



30V N&P-Channel Trench Power MOSFET

General Description

The SJH30NP370 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

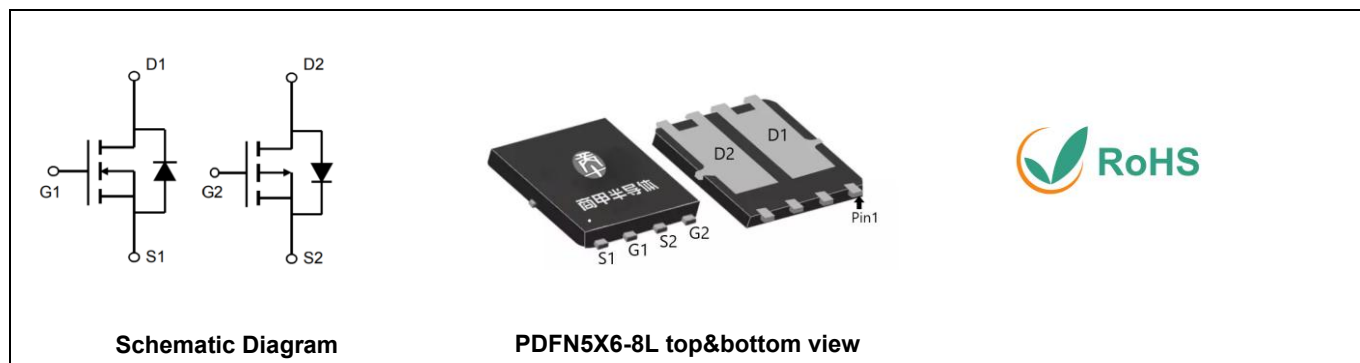
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Value	Unit
V_{DS}	30	-30	V
$R_{DS(ON_TYP)}$	10.4	25.6	m Ω
I_D	38	-17	A
Q_G	13	15	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH30NP370	SJH30NP370	PDFN5X6-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	N Limit	P Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	30	-30	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	± 20	V
I_D	Drain Current-Continuous($T_C=25^\circ\text{C}$)	38	-17	A
	Drain Current-Continuous($T_C=100^\circ\text{C}$)	24	-10	A
I_{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	152	-68	A
P_D	Maximum Power Dissipation($T_C=25^\circ\text{C}$)	30	14	W
	Maximum Power Dissipation($T_C=100^\circ\text{C}$)	12	5.6	W
E_{AS}	Avalanche energy (Note 2)	49	56	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150		$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	N Limit	P Limit	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	4.2	9	$^\circ\text{C}/\text{W}$



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Table 3. N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V, T_J=25^\circ\text{C}$			1	μA
		$V_{DS}=30V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1		2.5	V
g_{FS}	Forward Transconductance	$V_{DS}=5V, I_D=5A$		10		S
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=5A, T_J=25^\circ\text{C}$		10.4	13	m Ω
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=4.5V, I_D=4A, T_J=25^\circ\text{C}$		16.1	21.4	m Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1.0\text{MHz}$		756		pF
C_{oss}	Output Capacitance			90		pF
C_{rss}	Reverse Transfer Capacitance			73		pF
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		1.8		Ω
Switching Parameters						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=10V, V_{DS}=15V, R_L=3\Omega, R_{GEN}=3\Omega$		4.5		nS
t_r	Turn-on Rise Time			2.5		nS
$t_{d(off)}$	Turn-Off Delay Time			14.5		nS
t_f	Turn-Off Fall Time			3.5		nS
Q_g	Total Gate Charge	$V_{GS}=10V, V_{DS}=15V, I_D=5A$		14		nC
Q_{gs}	Gate-Source Charge			2		nC
Q_{gd}	Gate-Drain Charge			3		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				38	A
V_{SD}	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=5A$			1.2	V
t_{rr}	Reverse Recovery Time	$I_F=5A, dI/dt=500A/\mu s$		10		ns
Q_{rr}	Reverse Recovery Charge	$I_F=5A, dI/dt=500A/\mu s$		5		nC

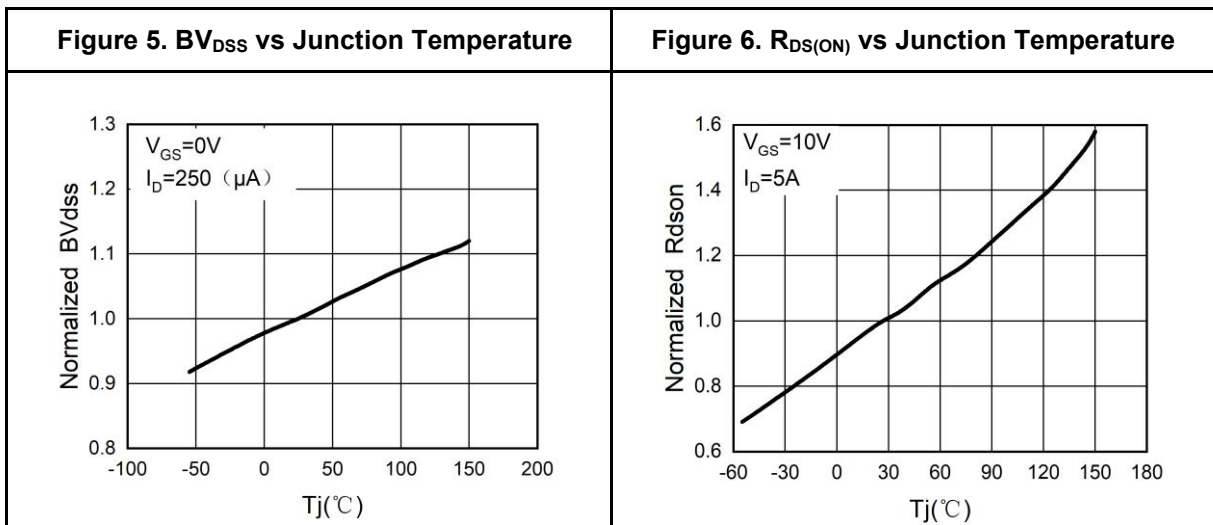
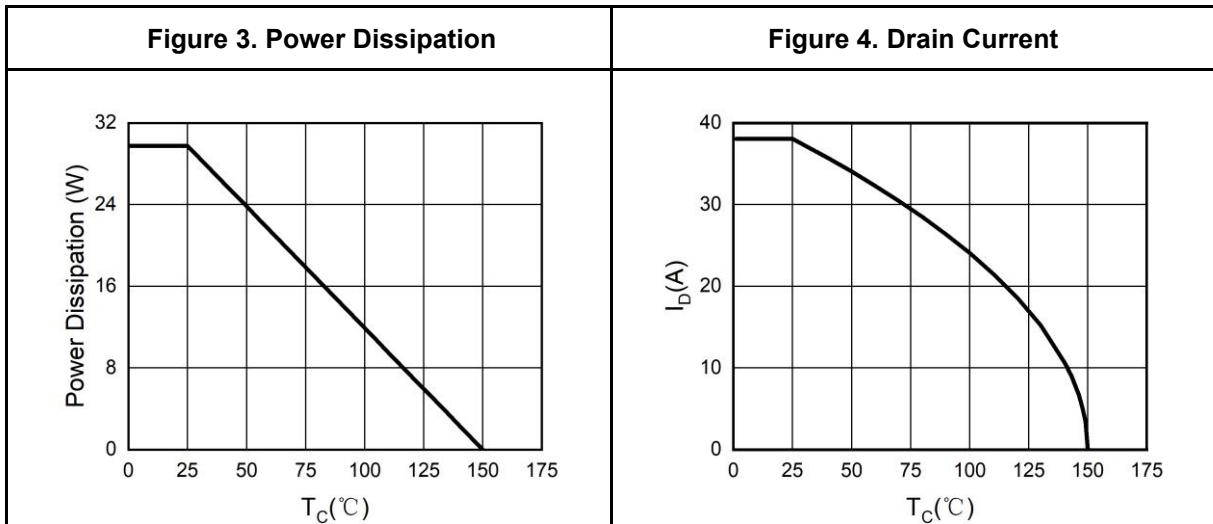
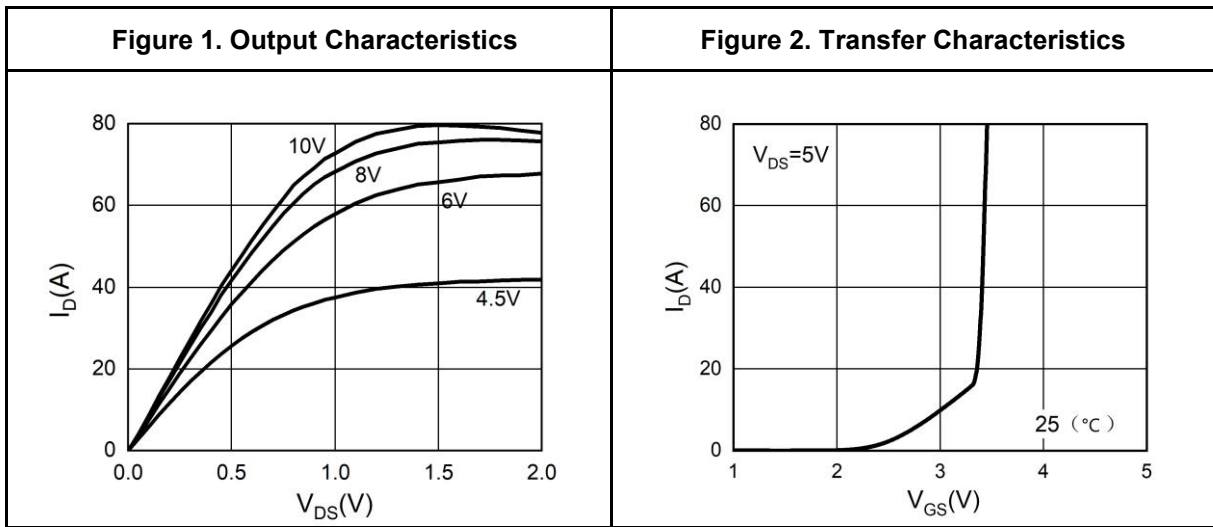
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.EAS condition: $T_J=25^\circ\text{C}, V_{DD}=30V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$.

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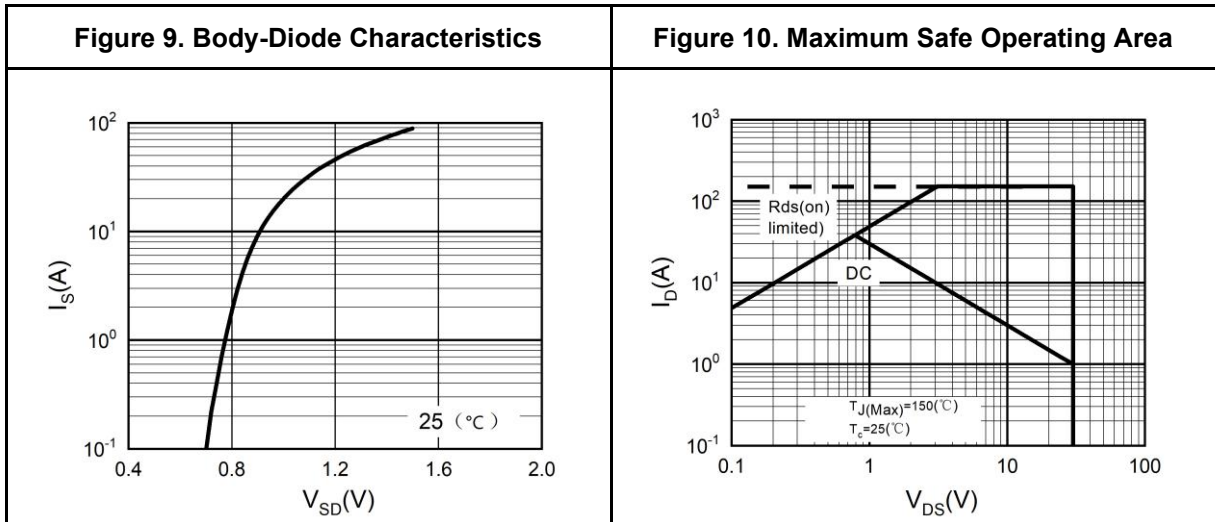
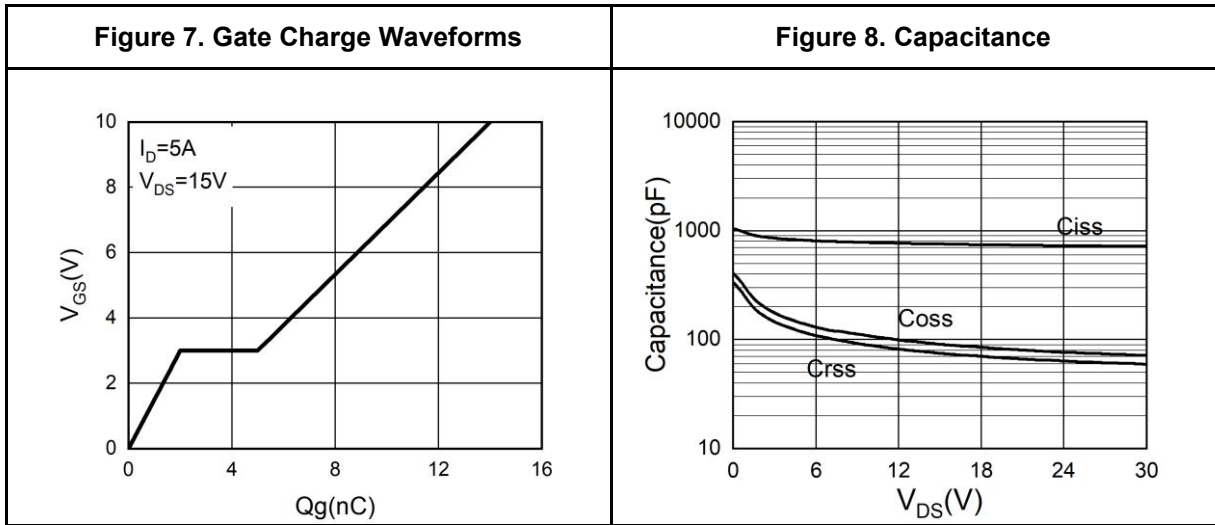


N-Channel Typical Electrical And Thermal Characteristics (Curves)





N-Channel Typical Electrical And Thermal Characteristics (Curves)





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Table 4. P-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-30V, V_{GS}=0V, T_J=25^\circ\text{C}$			-1	μA
		$V_{DS}=-30V, V_{GS}=0V, T_J=125^\circ\text{C}$			-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1		-2.5	V
g_{FS}	Forward Transconductance	$V_{DS}=-5V, I_D=-5A$		12		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-10V, I_D=-5A, T_J=25^\circ\text{C}$		25.6	32	m Ω
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-4.5V, I_D=-4A, T_J=25^\circ\text{C}$		36.5	48.5	m Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1.0\text{MHz}$		941		pF
C_{oss}	Output Capacitance			97		pF
C_{rss}	Reverse Transfer Capacitance			75		pF
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		8.9		Ω
Switching Parameters						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=-10V, V_{DS}=-15V, R_L=3\Omega, R_{GEN}=3\Omega$		13.4		nS
t_r	Turn-on Rise Time			3.4		nS
$t_{d(off)}$	Turn-Off Delay Time			42		nS
t_f	Turn-Off Fall Time			9		nS
Q_g	Total Gate Charge	$V_{GS}=-10V, V_{DS}=-15V, I_D=-5A$		15		nC
Q_{gs}	Gate-Source Charge			4		nC
Q_{gd}	Gate-Drain Charge			2		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				-17	A
V_{SD}	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=-5A$			-1.2	V
t_{rr}	Reverse Recovery Time	$I_F=-5A, dI/dt=-100A/\mu s$		15		ns
Q_{rr}	Reverse Recovery Charge	$I_F=-5A, dI/dt=-100A/\mu s$		6		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

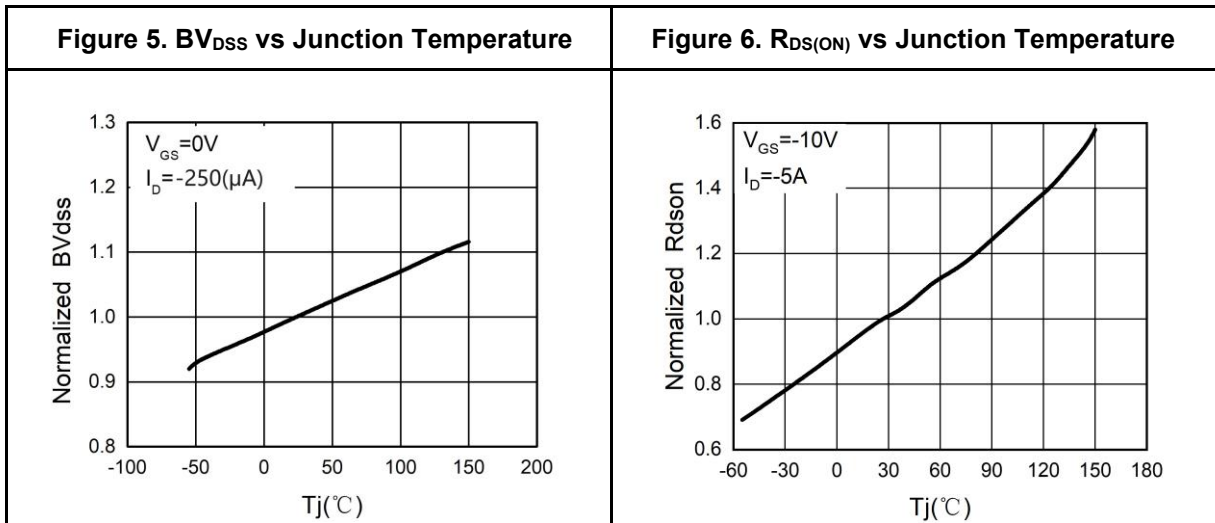
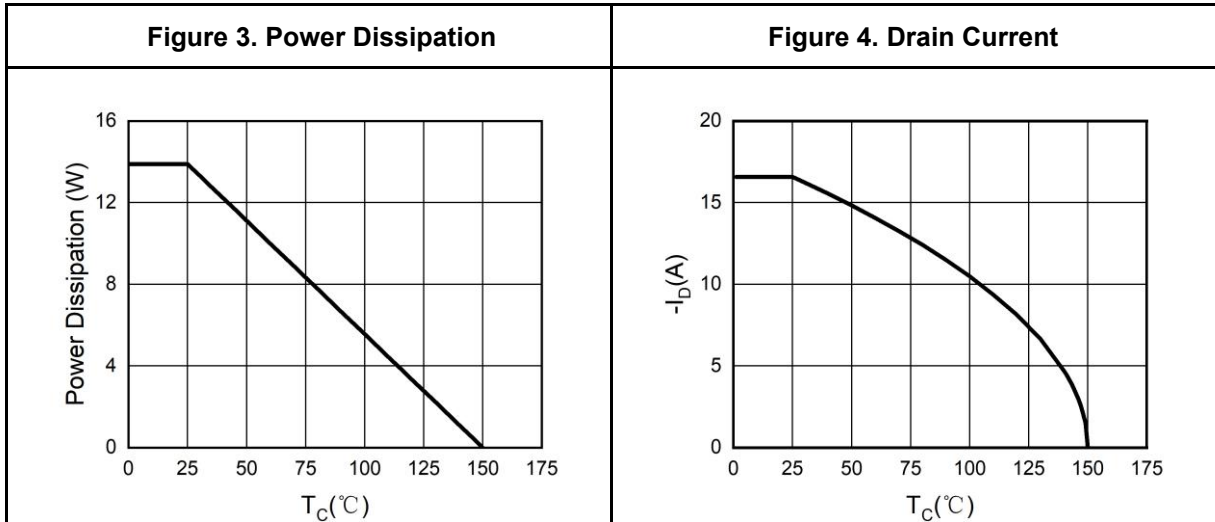
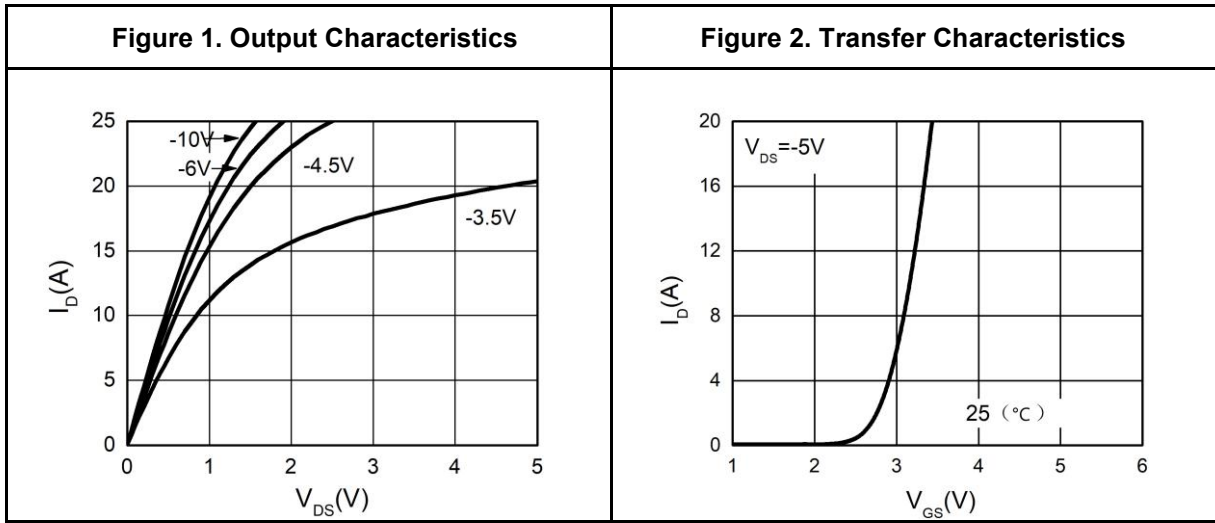
Notes 2.EAS condition: $T_J=25^\circ\text{C}, V_{DD}=-30V, V_G=-10V, R_g=25\Omega, L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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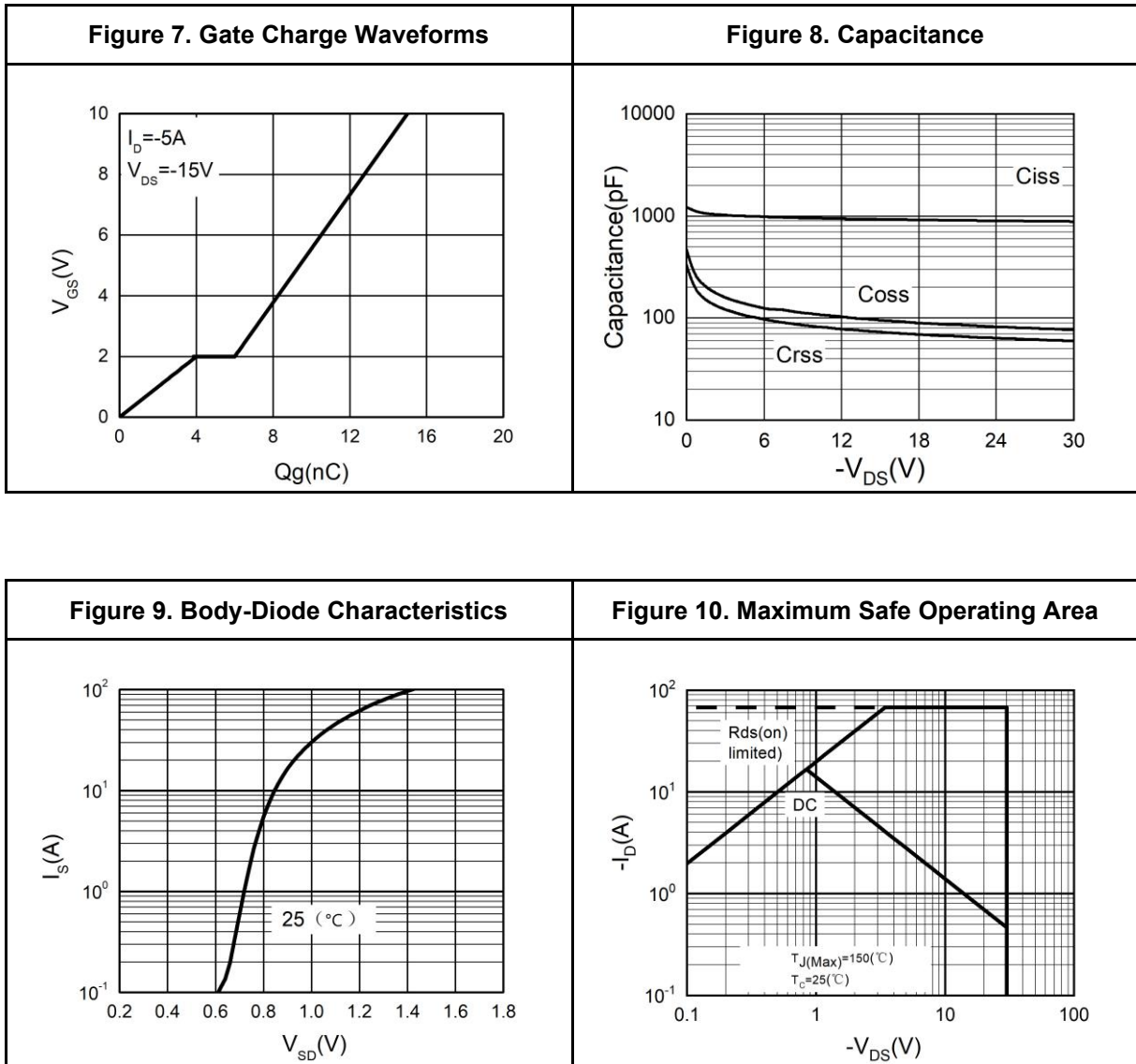
P-Channel Typical Electrical And Thermal Characteristics (Curves)





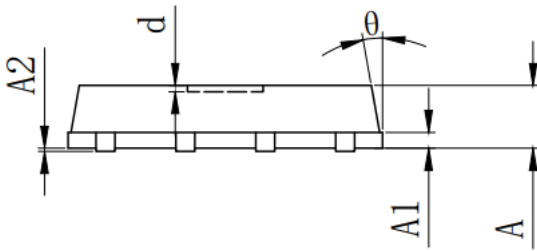
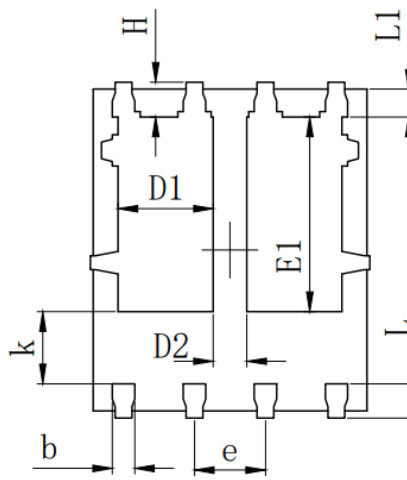
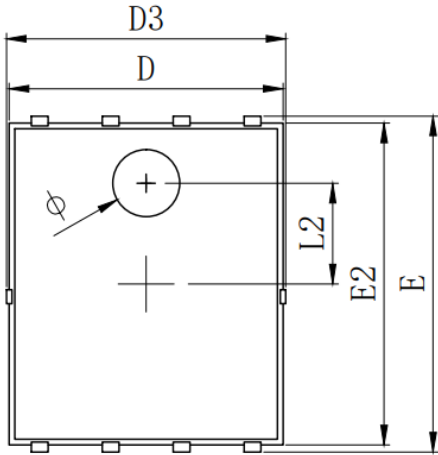
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P-Channel Typical Electrical And Thermal Characteristics (Curves)





PDFN5X6-8L Package Information



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1	0.254 REF.		
A2	0~0.05		
D	4.824	4.900	4.976
D1	1.605	1.705	1.805
D2	0.500	0.600	0.700
D3	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
H	0.549	0.625	0.701
theta	8°	10°	12°
phi	1.100	1.200	1.300
d			0.100



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Attention

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